# 1M x 1 Bit Static Random Access Memory

The MCM6227A is a 1,048,576 bit static random–access memory organized as 1,048,576 words of 1 bit, fabricated using high–performance silicon–gate CMOS technology. Static design eliminates the need for external clocks or timing strobes while CMOS circuitry reduces power consumption and provides for greater reliability.

The MCM6227A is equipped with a chip enable ( $\overline{E}$ ) pin. In less than a cycle time after  $\overline{E}$  goes high, the part enters a low–power standby mode, remaining in that state until  $\overline{E}$  goes low again.

The MCM6227A is available in 400 mil, 28-lead surface-mount SOJ packages.

- Single 5 V  $\pm$  10% Power Supply
- Fast Access Times: 20, 25, 35, and 45 ns
- Equal Address and Chip Enable Access Times
- Input and Output are TTL Compatible
- Three–State Output
- Low Power Operation: 160/140/130/120 mA Maximum, Active AC



**MCM6227A** 

PI	N ASSIGNI	MEN	Г
A0 [ A1 [ A2 [ A3 [ A4 [ A5 [ A6 [ A7 [ A8 [	1 ● 2 3 4 5 6 7 8 9 10	28 27 26 25 24 23 22 21 20 19	<ul> <li>VCC</li> <li>A19</li> <li>A18</li> <li>A17</li> <li>A16</li> <li>A15</li> <li>A14</li> <li>NC</li> <li>A13</li> <li>A12</li> </ul>
A9 [	11	18	A11
ая L Q [	11 12	18   17	A11 A10
₩ [ Vss [	13 14	16 ] 15 ]	D E

PIN NAMES										
$\begin{array}{cccc} A0 - A19 & & Address Inputs \\ \overline{W} & & Write Enable \\ \overline{E} & & Chip Enable \\ D & & Data Input \\ Q & & Data Output \\ NC & & No Connection \\ V_{CC} & & + 5 V Power Supply \\ V_{SS} & & Ground \\ \end{array}$										

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#### MCM6227A TRUTH TABLE

Ē	W	Mode	I/O Pin	Cycle	Current
Н	х	Not Selected	High–Z	_	I <sub>SB1</sub> , I <sub>SB2</sub>
L	Н	Read	D <sub>out</sub>	Read	ICCA
L	L	Write	High–Z	Write	ICCA

H = High, L = Low, X = Don't Care

#### ABSOLUTE MAXIMUM RATINGS (See Note)

Rating	Symbol	Value	Unit
Power Supply Voltage Relative to $V_{\ensuremath{SS}}$	VCC	– 0.5 to 7.0	V
Voltage Relative to VSS for Any Pin Except VCC	V <sub>in</sub> , V <sub>out</sub>	– 0.5 to V <sub>CC</sub> + 0.5	V
Output Current	l <sub>out</sub>	± 20	mA
Power Dissipation	PD	1.1	W
Temperature Under Bias	T <sub>bias</sub>	– 10 to + 85	°C
Operating Temperature	TA	0 to + 70	°C
Storage Temperature	T <sub>stg</sub>	– 55 to + 150	°C

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields; however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to these high–impedance circuits.

This CMOS memory circuit has been designed to meet the dc and ac specifications shown in the tables, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow of at least 500 linear feet per minute is maintained.

NOTE: Permanent device damage may occur if ABSOLUTE MAXIMUM RATINGS are exceeded. Functional operation should be restricted to RECOMMENDED OPER-ATING CONDITIONS. Exposure to higher than recommended voltages for extended periods of time could affect device reliability.

# DC OPERATING CONDITIONS AND CHARACTERISTICS

(V<sub>CC</sub> = 5.0 V  $\pm$  10%, T<sub>A</sub> = 0 to 70°C, Unless Otherwise Noted)

## **RECOMMENDED OPERATING CONDITIONS**

Parameter	Symbol	Min	Max	Unit
Supply Voltage (Operating Voltage Range)	VCC	4.5	5.5	V
Input High Voltage	VIH	2.2	V <sub>CC</sub> + 0.3**	V
Input Low Voltage	VIL	- 0.5*	0.8	V

\* VIL (min) = -0.5 V dc; VIL (min) = -2.0 V ac (pulse width  $\leq 20$  ns).

\*\* V<sub>IH</sub> (max) = V<sub>CC</sub> = 0.3 V dc; V<sub>IH</sub> (max) = V<sub>CC</sub> + 2 V ac (pulse width  $\leq$  20 ns).

## DC CHARACTERISTICS AND SUPPLY CURRENTS

Parameter	Symbol	Min	Тур*	Max	Unit
Input Leakage Current (All Inputs, $V_{in} = 0$ to $V_{CC}$ )	I <sub>lkg(I)</sub>	_	—	± 1	μΑ
Output Leakage Current ( $\overline{E} = V_{IH}$ , $V_{out} = 0$ to $V_{CC}$ )	l <sub>lkg(O)</sub>	_	—	± 1	μΑ
AC Active Supply Current ( $I_{out} = 0 \text{ mA}$ , $V_{CC} = max$ ) MCM6227A-20: $t_{AVAV} = 20 \text{ ns}$ MCM6227A-25: $t_{AVAV} = 25 \text{ ns}$ MCM6227A-35: $t_{AVAV} = 35 \text{ ns}$ MCM6227A-45: $t_{AVAV} = 45 \text{ ns}$	ICCA		120 110 100 90	160 140 130 120	mA
AC Standby Current (V <sub>CC</sub> = max, $\overline{E} = V_{IH}$ , f = f <sub>max</sub> )	I <sub>SB1</sub>		7	20	mA
CMOS Standby Current ( $\overline{E} \ge V_{CC} - 0.2 \text{ V}$ , $V_{in} \le V_{SS} + 0.2 \text{ V}$ or $\ge V_{CC} - 0.2 \text{ V}$ , $V_{CC} = \max$ , f = 0 MHz)	I <sub>SB2</sub>	_	4	15	mA
Output Low Voltage (I <sub>OL</sub> = + 8.0 mA)	VOL	—	—	0.4	V
Output High Voltage (I <sub>OH</sub> = - 4.0 mA)	VOH	2.4	—	—	V

\* Typical values are measured at 25°C, V<sub>CC</sub> = 5 V.

#### CAPACITANCE (f = 1.0 MHz, dV = 3.0 V, T<sub>A</sub> = 25°C, Periodically Sampled Rather Than 100% Tested)

	Characteristic				
Input Capacitance	All Inputs Except Clocks and D, Q $\overline{E}$ and $\overline{W}$	C <sub>in</sub>	4 5	6 8	pF
Input and Output Capacitance	D, Q	C <sub>in</sub> , C <sub>out</sub>	5	8	pF

#### AC OPERATING CONDITIONS AND CHARACTERISTICS

(V<sub>CC</sub> = 5.0 V  $\pm$  10%, T<sub>A</sub> = 0 to + 70°C, Unless Otherwise Noted)

Input Pulse Levels 0 to 3.0 V	
Input Rise/Fall Time 2 ns	
Input Timing Measurement Reference Level 1.5 V	

#### READ CYCLE TIMING (See Notes 1 and 2)

		6227	A–20	6227A–25 6227A–35		6227	A–45				
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Min	Max	Unit	Notes
Read Cycle Time	tAVAV	20	—	25	—	35	—	45	—	ns	2,3
Address Access Time	<sup>t</sup> AVQV	—	20	—	25	—	35	—	45	ns	
Enable Access Time	<sup>t</sup> ELQV	—	20	—	25	—	35	—	45	ns	4
Output Hold from Address Change	<sup>t</sup> AXQX	5	—	5	—	5	—	5	—	ns	
Enable Low to Output Active	<sup>t</sup> ELQX	5	—	5	_	5	—	5	—	ns	5, 6, 7
Enable High to Output High-Z	<sup>t</sup> EHQZ	0	9	0	10	0	12	—	18	ns	5, 6, 7
Power Up Time	<sup>t</sup> ELICCH	0	—	0	_	0	—	0	—	ns	
Power Down Time	<sup>t</sup> EHICCL		20	—	25	—	35	—	45	ns	

NOTES:

1.  $\overline{W}$  is high for read cycle.

2. Product sensitivities to noise require proper grounding and decoupling of power supplies as well as minimization or elimination of bus contention conditions during read and write cycles.

3. All timings are referenced from the last valid address to the first transitioning address.

4. Addresses valid prior to or coincident with  $\overline{E}$  going low.

5. At any given voltage and temperature, t<sub>EHQZ</sub> max is less than t<sub>ELQX</sub> min, both for a given device and from device to device.

6. Transition is measured ± 500 mV from steady-state voltage with load of Figure 1B.

7. This parameter is sampled and not 100% tested.

8. Device is continuously selected ( $\overline{E} \leq V_{IL}$ ).

#### AC TEST LOADS



#### TIMING LIMITS

The table of timing values shows either a minimum or a maximum limit for each parameter. Input requirements are specified from the external system point of view. Thus, address setup time is shown as a minimum since the system must supply at least that much time (even though most devices do not require it). On the other hand, responses from the memory are specified from the device point of view. Thus, the access time is shown as a maximum since the device never provides data later than that time.







## WRITE CYCLE 1 (W Controlled, See Notes 1 and 2)

		6227	6227A–20 6227A–25 6227A–35		6227	A–45					
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Min	Max	Unit	Notes
Write Cycle Time	t <sub>AVAV</sub>	20	—	25	—	35		45	—	ns	3
Address Setup Time	<sup>t</sup> AVWL	0	—	0	—	0	-	0	—	ns	
Address Valid to End of Write	<sup>t</sup> AVWH	15	—	17	—	20	-	25	—	ns	
Write Pulse Width	<sup>t</sup> WLWH, <sup>t</sup> WLEH	15	_	17	_	20	-	25	_	ns	
Data Valid to End of Write	<sup>t</sup> DVWH	10	—	10	—	15	-	20	—	ns	
Data Hold Time	<sup>t</sup> WHDX	0	—	0	—	0	-	0	—	ns	
Write Low to Data High–Z	twlqz	0	9	0	10	0	15	0	20	ns	4, 5, 6
Write High to Output Active	<sup>t</sup> WHQX	5	—	5	—	5	—	5	—	ns	4, 5, 6
Write Recovery Time	tWHAX	0	—	0	—	0		0	—	ns	

NOTES:

1. A write occurs during the overlap of  $\overline{E}$  low and  $\overline{W}$  low.

2. Product sensitivities to noise require proper grounding and decoupling of power supplies as well as minimization or elimination of bus contention conditions during read and write cycles.

3. All timings are referenced from the last valid address to the first transitioning address.

4. Transition is measured  $\pm$  500 mV from steady–state voltage with load of Figure 1B.

5. This parameter is sampled and not 100% tested.

6. At any given voltage and temperature, tWLQZ max is less than tWHQX min both for a given device and from device to device.



WRITE CYCLE 1 (W Controlled See Notes 1 and 2)

#### WRITE CYCLE 2 (E Controlled, See Notes 1 and 2)

		6227A–20 6227A–25		6227A–35 6227A–45			A-45				
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Min	Max	Unit	Notes
Write Cycle Time	t <sub>AVAV</sub>	20	—	25	—	35		45	—	ns	3
Address Setup Time	<sup>t</sup> AVEL	0	—	0	—	0		0	—	ns	
Address Valid to End of Write	<sup>t</sup> AVEH	15	—	17	—	20		25	—	ns	
Enable to End of Write	<sup>t</sup> ELEH, <sup>t</sup> ELWH	15	—	17	—	20	-	25	—	ns	4, 5
Write Pulse Width	<sup>t</sup> WLEH	15	—	17	—	20		25	_	ns	
Data Valid to End of Write	<sup>t</sup> DVEH	10	—	10	—	15		20	_	ns	
Data Hold Time	<sup>t</sup> EHDX	0	—	0	—	0	—	0	_	ns	
Write Recovery Time	<sup>t</sup> EHAX	0	_	0	—	0	_	0	_	ns	

NOTES:

1. A write occurs during the overlap of  $\overline{E}$  low and  $\overline{W}$  low.

2. Product sensitivities to noise require proper grounding and decoupling of power supplies as well as minimization or elimination of bus contention conditions during read and write cycles.

3. All timings are referenced from the last valid address to the first transitioning address.

4. If  $\overline{E}$  goes low coincident with or after  $\overline{W}$  goes low, the output will remain in a high-impedance state.

5. If  $\overline{E}$  goes high coincident with or before  $\overline{W}$  goes high, the output will remain in a high-impedance state.



## WRITE CYCLE 2 (E Controlled See Notes 1 and 2)

#### ORDERING INFORMATION (Order by Full Part Number)



## PACKAGE DIMENSIONS

28 LEAD 400 MIL SOJ CASE 810-03



- NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. DIMENSION A & B DO NOT INCLUDE MOLD PROTRUSION. MOLD PROTRUSION SHALL NOT EXCEED 0.15 (0.006) PER SIDE. 3. CONTROLLING DIMENSION: INCH. 4. DIM R TO BETERMINED AT DATUM -T.

	MILLIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	18.29	18.54	0.720	0.730
B	10.04	10.28	0.395	0.405
C	3.26	3.75	0.128	0.148
D	0.39	0.50	0.015	0.020
E	2.24	2.48	0.088	0.098
F	0.67	0.81	0.026	0.032
G	1.27	BSC	0.050	BSC
н	—	0.50	-	0.020
K	0.89	1.14	0.035	0.045
L	0.64	BSC	0.025	BSC
M	0°	5°	0°	5°
N	0.76 1.14		0.030	0.045
Р	11.05	11.30	0.435	0.445
R	9.15	9.65	0.360	0.380
S	0.77	1.01	0.030	0.040

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MCM6227A/D

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